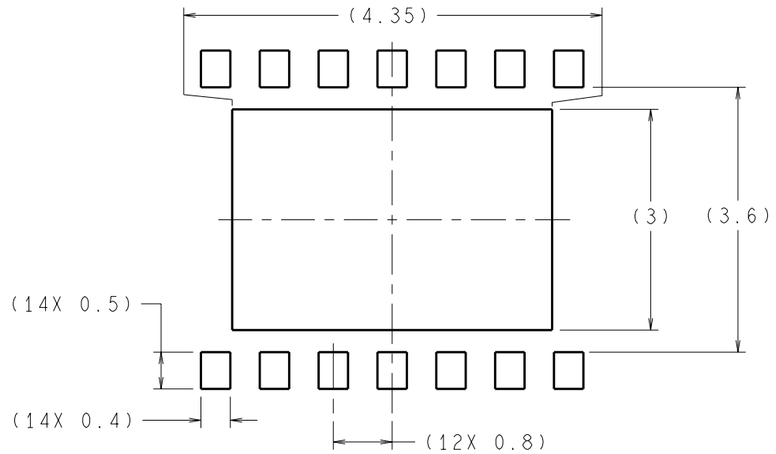
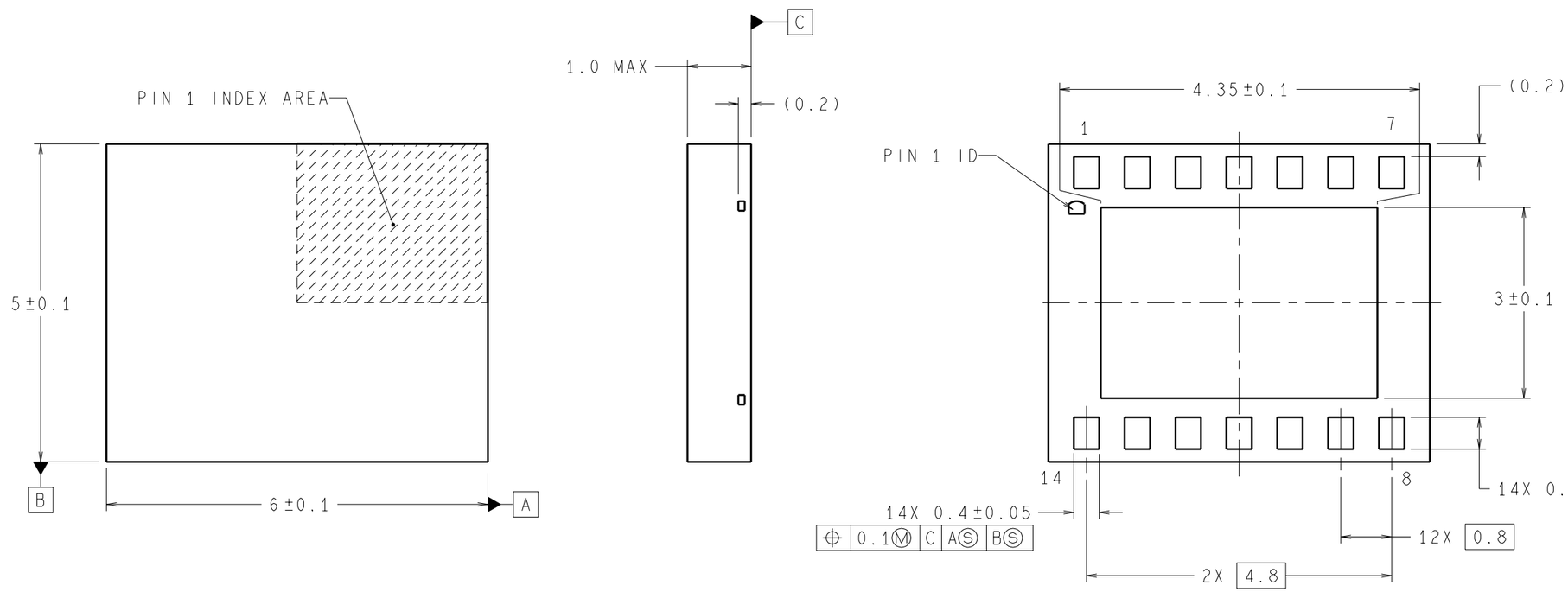
REVISIONS				
LTR	DESCRIPTION	E.C.N.	DATE	BY/APP'D
A	RELEASE TO DOCUMENT CONTROL	12601	12/12/2000	AS/MS/NS



RECOMMENDED LAND PATTERN
1:1 RATIO WITH PKG SOLDER PADS

DIMENSIONS ARE IN MILLIMETERS



NOTES: UNLESS OTHERWISE SPECIFIED

1. STANDARD LEAD FINISH TO BE 5.08 MICROMETERS MINIMUM LEAD/TIN (SOLDER) ON COPPER.

2. NO JEDEC REGISTRATION AS OF DECEMBER 2000.

APPROVALS	DATE
DRAWN AFZNIZAM S.	12/06/2000
DFTG. CHK. MARTA SUCHY	12/12/2000
ENGR. CHK. N. SANTHIRAN	12/12/2000

PROJECTION INCH [MM]

National Semiconductor
2900 Semiconductor Dr, Santa Clara, CA 95052-8090

POWER LLP, PLASTIC, DUAL, 6 X 5 X 1.0 mm BODY, 14 LD, 0.8 mm PITCH

SCALE	SIZE	DRAWING NUMBER	REV
N/A	C	(SC)MKT-LDC14A	A

FORMERLY: N/A

SHEET 1 of 1